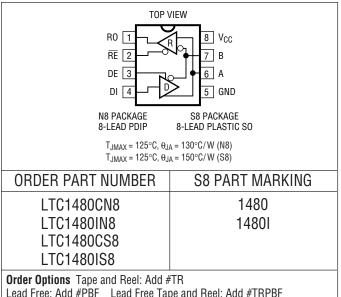
ABSOLUTE MAXIMUM RATINGS

(Note 1)	
Supply Voltage (V _{CC}) 7\	V
Control Input Voltage $-0.3V$ to $V_{CC} + 0.3V$	V
Driver Input Voltage $-0.3V$ to $V_{CC} + 0.3V$	V
Driver Output Voltage ±14\	V
Receiver Input Voltage ±14\	V
Receiver Output Voltage $-0.3V$ to $V_{CC} + 0.3V$	V
Operating Temperature Range	
LTC1480C $0^{\circ}C \le T_{A} \le 70^{\circ}C$	С
LTC1480I $-40^{\circ}\text{C} \le T_{A} \le 85^{\circ}\text{C}$	С
Storage Temperature Range65°C to 150°C	С
Lead Temperature (Soldering, 10 sec)300°C	C

PACKAGE/ORDER INFORMATION



Lead Free: Add #PBF Lead Free Tape and Reel: Add #TRPBF

Lead Free Part Marking: http://www.linear.com/leadfree/

Consult LTC Marketing for parts specified with wider operating temperature ranges.

ELECTRICAL CHARACTERISTICS The • denotes the specifications which apply over the full operating temperature range. $V_{CC} = 3.3V$ (Notes 2, 3).

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
V_{OD1}	Differential Driver Output Voltage (Unloaded)	I ₀ = 0V	•			3.3	V
V _{OD2}	Differential Driver Output Voltage (with Load)	R = 27Ω (RS485) (Figure 1) R = $50Ω$ (RS422)	•	1.5 2.0		3.3	V
ΔV_{0D}	Change in Magnitude of Driver Differential Output Voltage for Complementary Output States	$R = 27\Omega$ or $R = 50\Omega$ (Figure 1)	•			0.2	V
V _{OC}	Driver Common Mode Output Voltage	$R = 27\Omega$ or $R = 50\Omega$ (Figure 1)	•			2	V
$\Delta V_{0C} $	Change in Magnitude of Driver Common Mode Output Voltage for Complementary Output States	$R = 27\Omega$ or $R = 50\Omega$ (Figure 1)	•			0.2	V
V_{IH}	Input HIGH Voltage	DE, DI, RE	•	2			V
V_{IL}	Input LOW Voltage	DE, DI, RE	•			8.0	V
I _{IN1}	Input Current	DE, DI, RE	•			±2	μА
I _{IN2}	Input Current (A, B)	DE = 0, V _{CC} = 0V or 3.6V, V _{IN} = 12V DE = 0, V _{CC} = 0V or 3.6V, V _{IN} = -7V	•			1.0 -0.8	mA mA
$\overline{V_{TH}}$	Differential Input Threshold Voltage for Receiver	$-7V \le V_{CM} \le 12V$	•	-0.2		0.2	V
ΔV_{TH}	Receiver Input Hysteresis	$V_{CM} = 0V$			70		mV
V _{OH}	Receiver Output HIGH Voltage	$I_0 = -4mA, V_{ID} = 200mV$	•	2			V
V _{OL}	Receiver Output LOW Voltage	$I_0 = 4mA, V_{ID} = -200mV$	•			0.4	V
I _{OZR}	Three-State (High Impedance) Output Current at Receiver	$V_{CC} = Max, 0.4V \le V_0 \le 2.4V$	•			±1	μА
R _{IN}	Receiver Input Resistance	$-7V \le V_{CM} \le 12V$	•	12			kΩ
I _{CC}	Supply Current	No Load, Output Enabled No Load, Output Disabled	•		400 300	600 500	μA μA
I _{SHDN}	Supply Current in Shutdown Mode	$DE = 0$, $\overline{RE} = V_{CC}$			1	10	μА



SWITCHING CHARACTERISTICS The • denotes the specifications which apply over the full operating

temperature range. $V_{CC} = 3.3V$ (Notes 2, 3).

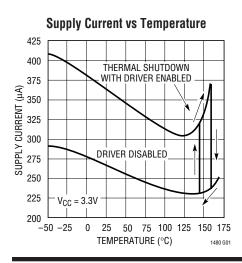
SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
I _{OSD1}	Driver Short-Circuit Current, V _{OUT} = HIGH	$-7V \le V_0 \le 12V$	•	35		250	mA
I _{OSD2}	Driver Short-Circuit Current, V _{OUT} = LOW	$-7V \le V_0 \le 12V$	•	35		250	mA
I _{OSR}	Receiver Short-Circuit Current	$0V \le V_0 \le V_{CC}$	•	7		85	mA
t _{PLH}	Driver Input to Output	$R_{DIFF} = 54\Omega$, $C_{L1} = C_{L2} = 100pF$, (Figures 3, 5)	•	25	50	80	ns
t _{PHL}	Driver Input to Output		•	25	50	80	ns
t _{SKEW}	Driver Output to Output		•		10	20	ns
t _R , t _F	Driver Rise or Fall Time		•	5	15	40	ns
t _{ZH}	Driver Enable to Output HIGH	C _L = 100pF (Figures 4, 6), S2 Closed	•		70	120	ns
t _{ZL}	Driver Enable to Output LOW	C _L = 100pF (Figures 4, 6), S1 Closed	•		70	120	ns
t_{LZ}	Driver Disable Time from LOW	C _L = 15pF (Figures 4, 6), S1 Closed	•		70	120	ns
t _{HZ}	Driver Disable Time from HIGH	C _L = 15pF (Figures 4, 6), S2 Closed	•		70	120	ns
t _{PLH}	Receiver Input to Output	R_{DIFF} = 54 Ω , C_{L1} = C_{L2} = 100pF, (Figures 3, 7)	•	30	140	200	ns
t _{PHL}	Receiver Input to Output		•	30	140	200	ns
t _{SKD}	t _{PLH} - t _{PHL} Differential Receiver Skew				13		ns
t_{ZL}	Receiver Enable to Output LOW	C _{RL} = 15pF (Figures 2, 8), S1 Closed	•		50	80	ns
t _{ZH}	Receiver Enable to Output HIGH	C _{RL} = 15pF (Figures 2, 8), S2 Closed	•		50	80	ns
t_{LZ}	Receiver Disable from LOW	C _{RL} = 15pF (Figures 2, 8), S1 Closed	•		50	80	ns
t _{HZ}	Receiver Disable from HIGH	C _{RL} = 15pF (Figures 2, 8), S2 Closed	•		50	80	ns
f _{MAX}	Maximum Data Rate		•	2.5			Mbits/s
t _{SHDN}	Time to Shutdown	DE = 0, RE = _	•	50	200	600	ns
t _{ZH(SHDN)}	Driver Enable from Shutdown to Output HIGH	C _L = 100pF (Figures 4, 6), S2 Closed	•		70	120	ns
t _{ZL(SHDN)}	Driver Enable from Shutdown to Output LOW	C _L = 100pF (Figures 4, 6), S1 Closed	•		70	120	ns
t _{ZH(SHDN)}	Receiver Enable from Shutdown to Output HIGH	C _L = 15pF (Figures 2, 8), S2 Closed	•			4500	ns
t _{ZL(SHDN)}	Receiver Enable from Shutdown to Output LOW	C _L = 15pF (Figures 2, 8), S1 Closed	•			4500	ns

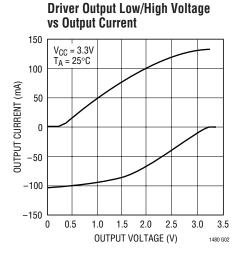
Note 1: Absolute maximum ratings are those beyond which the safety of the device cannot be guaranteed.

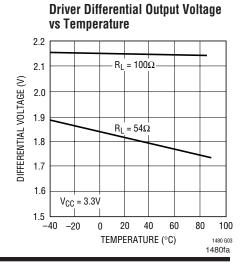
Note 2: All currents into device pins are positive; all currents out ot device pins are negative. All voltages are referenced to device ground unless otherwise specified.

Note 3: All typicals are given for $V_{CC} = 3.3V$ and $T_A = 25^{\circ}C$.

TYPICAL PERFORMANCE CHARACTERISTICS

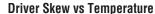


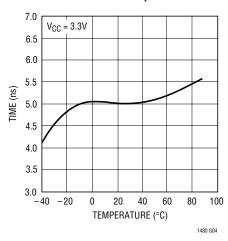




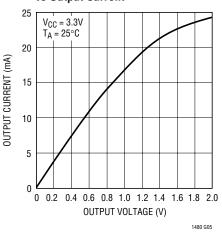


TYPICAL PERFORMANCE CHARACTERISTICS

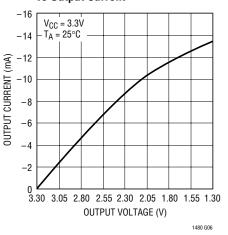




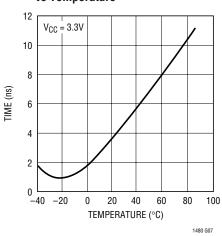
Receiver Output Low Voltage vs Output Current



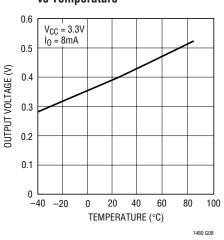
Receiver Output High Voltage vs Output Current



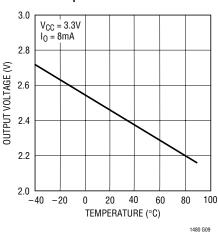
Receiver | t_{PLH} - t_{PHL} | vs Temperature



Receiver Output Low Voltage vs Temperature



Receiver Output High Voltage vs Temperature



PIN FUNCTIONS

RO (Pin 1): Receiver Output. If the receiver output is enabled (\overline{RE} LOW) and A > B by 200mV, then RO will be HIGH. If A < B by 200mV, then RO will be LOW.

RE (Pin 2): Receiver Output Enable. A LOW enables the receiver output, RO. A HIGH input forces the receiver output into a high impedance state.

DE (Pin 3): Driver Outputs Enable. A HIGH on DE enables the driver output. A, B and the chip will function as a line driver. A low input will force the driver outputs into a high impedance state and the chip will function as a line receiver. If \overline{RE} is high and DE is LOW, the part will enter a low power (1 μ A) shutdown state. If \overline{RE} is low and DE is

high, the driver outputs will be fed back to the receiver and the receive output will correspond to the driver input.

DI (Pin 4): Driver Input. If the driver outputs are enabled (DE HIGH) then a low on DI forces the outputs A LOW and B HIGH. A HIGH on DI with the driver outputs enabled will force A HIGH and B LOW.

GND (Pin 5): Ground.

A (Pin 6): Driver Output/Receiver Input.

B (Pin 7): Driver Output/Receiver Input.

 V_{CC} (Pin 8): Positive Supply. 3.0V < V_{CC} < 3.6V.

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FUNCTION TABLES

LTC1480 Transmitting

INPUTS			OUT	PUTS
RE	DE	DI	В	Α
X	1	1	0	1
Х	1	0	1	0
0	0	Х	Z	Z
1	0	Х	Z*	Z*

^{*}Shutdown mode

LTC1480 Receiving

INPUTS			OUTPUTS	
	RE	DE	A – B	R0
	0	0	≥0.2V	1
	0	0	≤-0.2V	0
	0	0	Inputs Open	1
	1	0	Х	Z*

^{*}Shutdown mode

TEST CIRCUITS

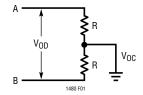


Figure 1. Driver DC Test Load

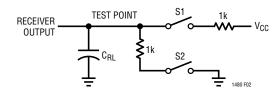


Figure 2. Receiver Timing Test Load

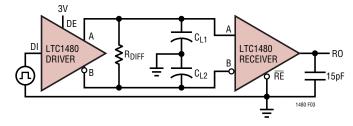


Figure 3. Driver/Receiver Timing Test Circuit

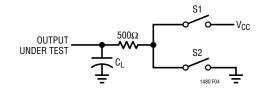


Figure 4. Driver Timing Test Load

SWITCHING TIME WAVEFORMS

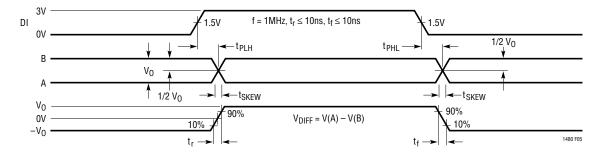


Figure 5. Driver Propagation Delays

SWITCHING TIME WAVEFORMS

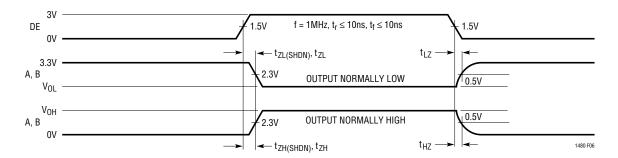


Figure 6. Driver Enable and Disable Times

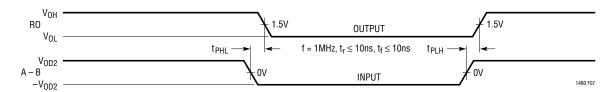


Figure 7. Receiver Propagation Delays

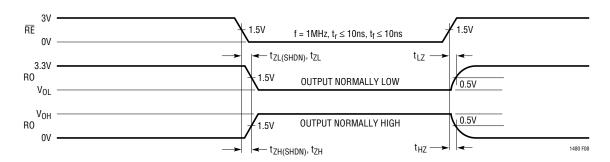
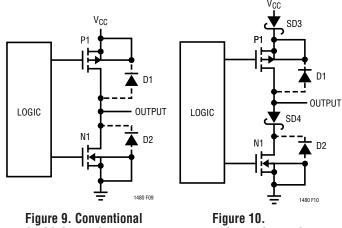


Figure 8. Receiver Enable and Disable Times

APPLICATIONS INFORMATION

CMOS Output Driver

The LTC1480 transceiver provides full RS485 compatibility while operating from a single 3.3V supply. The RS485 specification requires that a transceiver withstand common mode voltages of up to 12V or -7V at the RS485 line connections. Additionally, the transceiver must be immune to both ESD and latch-up. This rules out traditional CMOS drivers, which include parasitic diodes from their driver outputs to each supply rail (Figure 9). The LTC1480 uses a proprietary process enhancement which adds a pair of Schottky diodes to the output stage (Figure 10), preventing



CMOS Output Stage

LTC1480 Output Stage



APPLICATIONS INFORMATION

current from flowing when the common mode voltage exceeds the supply rails. Latch-up at the output drivers is virtually eliminated and the driver is prevented from loading the line under RS485 specified fault conditions.

When two or more drivers are connected to the same transmission line, a potential condition exists whereby more than two drivers are simultaneously active. If one or more drivers is sourcing current while another driver is sinking current, excessive power dissipation may occur within either the sourcing or sinking element. This condition is defined as driver contention, since multiple drivers are competing for one transmission line. The LTC1480 provides a current limiting scheme to prevent driver contention failure. When driver contention occurs, the current drawn is limited to about 70mA preventing excessive power dissipation within the drivers.

The LTC1480 has a thermal shutdown feature which protects the part from excessive power dissipation. Under extreme fault conditions, up to 250mA can flow through the part causing rapid internal temperature rise. The thermal shutdown circuit will disable the driver outputs when the internal temperature reaches 150°C and turns them back on when the temperature cools to 130°C. This cycle will repeat as necessary until the fault condition is removed.

Receiver Inputs

The LTC1480 features an input common mode range covering the entire RS485 specified range of -7V to 12V. Differential signals of greater than ± 200 mV within the specified input common mode range will be converted to a TTL compatible signal at the receiver output. A small amount of input hysteresis is included to minimize the effects of noise on the line signals. If the receiver inputs are floating (unterminated) an internal pull-up of $10\mu A$ at the A input will force the receiver output to a known high state.

Low Power Operation

The LTC1480 draws very little supply current whenever the driver outputs are disabled. In shutdown mode the quiescent current is typically less than $1\mu A$. With the receiver active and the driver outputs disabled, the LTC1480 will typically draw $300\mu A$ quiescent current. With the

driver outputs enabled but unterminated, quiescent current will rise as one of the two outputs sources current into the internal receiver input resistance. With the minimum receiver input resistance of 12k and the maximum output swing of 3.3V, the quiescent current will rise by a maximum of $275\mu A$. Typical quiescent current rise with the driver enabled is about $100\mu A$.

The quiescent current rises significantly if the driver is enabled when it is externally terminated. With 1/2 termination load (120 Ω between the driver outputs) the quiescent current will jump to at least 13mA as the drivers force a minimum of 1.5V across the termination resistance. With a fully terminated 60Ω line attached, the current will rise to greater than 25mA with the driver enabled, completely overshadowing the extra $100\mu\text{A}$ drawn by internal receiver inputs.

Shutdown Mode

Both the receiver output (RO) and the driver outputs (A, B) can be placed in three-state mode by bringing RE HIGH and DE LOW respectively. In addition, the LTC1480 will enter shutdown mode when RE is HIGH and DE is LOW.

In shutdown the LTC1480 typically draws only $1\mu A$ of supply current. In order to guarantee that the part goes into shutdown, \overline{RE} must be high and DE must be LOW for at least 600ns simultaneously. If this time duration is less than 50ns the part will not enter shutdown mode.

Propagation Delay

Many digital encoding schemes are dependent upon the difference in the propagation delay times of the driver and receiver. Figure 11 shows the test circuit for the LTC1480 propagation delay.

The receiver delay times are:

$$|t_{Pl H} - t_{PHI}| = 13 \text{ns Typ}, V_{CC} = 3.3 \text{V}$$

The driver's skew times are:

$$t_{SKEW}$$
 = 10ns Typ, V_{CC} = 3.3V
20ns Max, V_{CC} = 3.3V, T_A = -40°C to 85°C

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APPLICATIONS INFORMATION

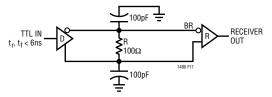
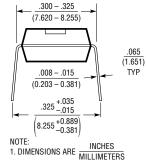


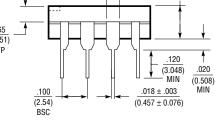
Figure 11. Receiver Propagation Delay Test Circuit

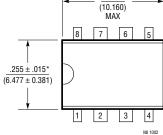
PACKAGE DESCRIPTION

N8 Package 8-Lead PDIP (Narrow .300 Inch) (Reference LTC DWG # 05-08-1510)

.130 ± .005 .045 - .065 $(\overline{1.143 - 1.651})$ (3.302 ± 0.127)







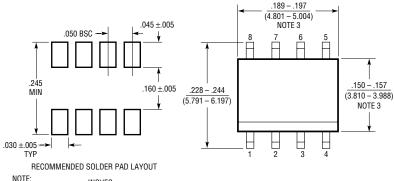
.053 - .069

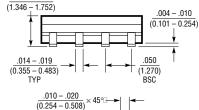
.400*

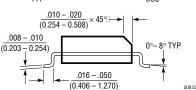
*THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED .010 INCH (0.254mm)

S8 Package 8-Lead Plastic Small Outline (Narrow .150 Inch)

(Reference LTC DWG # 05-08-1610)







1. DIMENSIONS IN (MILLIMETERS) 2. DRAWING NOT TO SCALE

3. THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED .006" (0.15mm)

RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LTC485	5V Low Power RS485 Interface Transceiver	Low Power
LTC1481	5V Ultralow Power RS485 Transceiver with Shutdown	Lowest Power
LTC1483	5V Ultralow Power RS485 Low EMI Transceiver with Shutdown	Low EMI/Lowest Power
LTC1485	5V Differential Bus Transceiver	High Speed, 10Mbps
LTC1487	5V Ultralow Power RS485 with Low EMI, Shutdown and High Input Impedance	High Input Impedance/Low EMI/Lowest Power

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